

**AMENDMENTS TO THE CLAIMS, COMPLETE LISTING OF CLAIMS  
IN ASCENDING ORDER WITH STATUS INDICATOR**

Please amend the claims as follows.

1. (Currently Amended) A conductive particle comprising: ~~of which the surface of a base particle; core materials disposed on the surface of the base particle; and is covered with a conductive film or conductive films and which has projections formed by projecting of said conductive film or conductive films, wherein a core material for projecting the surface of said conductive film is provided on covering the surface of said base particle and said core material materials;~~  
~~wherein projections are formed on the outer surface of the conductive film or conductive films; and~~  
~~wherein the core materials is are composed of a conductive material different from a conductive material composing said conductive film or conductive films.~~
2. (Currently Amended) The conductive particle according to claim 1, wherein each of ~~said core material materials~~ has a shape in lump form.
3. (Currently Amended) The conductive particle according to claim 1 or 2, wherein the outermost surface of said conductive film is a gold layer.
4. (Currently Amended) A conductive particle comprising: ~~a base particle; wherein said conductive particle has a core materials material in particle form, composed of a conductive material, disposed on the surface of a the base particle and made of a conductive material; and, a plated coat covering the surface of said base particle and said core material materials; are covered with a plated coat and said conductive particle has~~

wherein projections are formed by projecting of on the outer surface of said plated coat by thus covering said core material.

5. (Currently Amended) The conductive particle according to claim 4, wherein at least 80% or more of said core materials-material existing on the surface of said base particle contacts with said base particle or exists within a range of 5 nm from said base particle.

6. (Currently Amended) The conductive particle according to claim 4 or 5, wherein the outermost surface of said plated coat is a gold layer.

7. (Currently Amended) The conductive particle according to claim 1 or 4, wherein said core materials material is are composed of at least one or more species of metal.

8. (Currently Amended) The conductive particle according to claim 1 or 4, wherein said base particle is a resin particle.

9. (Currently Amended) The conductive particle according to claim 1 or 4, wherein an average height of said projections projection portions projecting is 0.5% or more of an average particle diameter of the said conductive particle particles.

10. (Currently Amended) An anisotropic conductive material comprising a resin binder and, wherein the conductive particle particles according to claim 1 or 4 are dispersed in a said resin binder.